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Vishay General Semiconductor

FEATURES

· Glass passivated chip junction



- · Ideal for automated placement
- Ultrafast recovery times for high efficiency
- the factor of the state of the



Low forward voltage, low power loss

ROHS

- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC

DO-214AA (SMB)

TYPICAL APPLICATIONS

For use in high frequency rectification and freewheeling application in switching mode converter and inverter for both consumer and automotive.

MECHANICAL DATA

Case: DO-214AA (SMB)

Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS compliant, commercial grade Base P/NHE3 - RoHS compliant, AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test, HE3 suffix

meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

PRIMARY CHARACTERISTICS					
I _{F(AV)}	2.0 A				
V _{RRM}	100 V, 150 V, 200 V				
t _{rr}	25 ns				
V _F	0.93 V				
T _J max.	175 °C				

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	ESH2B	ESH2C	ESH2D	UNIT	
Device marking code		EHB	EHC	EHD		
Maximum repetitive peak reverse voltage	V_{RRM}	100	150	200	V	
Maximum RMS voltage	V _{RMS}	70	105	140	V	
Maximum DC blocking voltage	V_{DC}	100	150	200	V	
Maximum average forward rectified current (fig. 1)	I _{F(AV)}	2.0			А	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	60			А	
Operating junction and storage temperature range	T _J , T _{STG}	- 55 to + 175			°C	



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	VALUE	UNIT	
Maximum instantaneous forward voltage	I _F = 2 A		V _F ⁽¹⁾	0.93	V	
Maximum DC reverse current at rated DC blocking voltage		T _A = 25 °C	1	2.0	μΑ	
		T _A = 125 °C	- I _R	50		
Maximum reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1 \text{ A}, I_{rr} = 0.25 \text{ A}$		t _{rr}	25	ns	
Typical reverse recovery time	$I_F = 2 \text{ A, } V_R = 30 \text{ V,}$ $dI/dt = 50 \text{ A/}\mu\text{s, } I_{rr} = 10 \% I_{RM}$	T _J = 25 °C	- t _{rr}	35	ns	
		T _J = 100 °C		55		
Typical stored charge	$I_F = 2 \text{ A}, V_R = 30 \text{ V},$	T _J = 25 °C	0	20	nC	
	dI/dt = 50 A/ μ s, I _{rr} = 10 % I _{RM} $T_J = 100 ^{\circ}$ C		- Q _{rr}	35	110	
Typical junction capacitance	4.0 V, 1 MHz		CJ	30	pF	

Note

⁽¹⁾ Pulse test: 300 µs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	ESH2B	ESH2C	ESH2D	UNIT	
Typical thermal resistance	R _{θJA} ⁽¹⁾	65			°C/W	
Typical thermal resistance	R _{0JL} (1)		20		C/VV	

Note

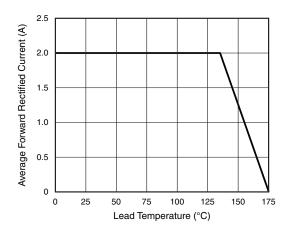
 $^{^{(1)}}$ Units mounted on P.C.B. with 8.0 mm x 8.0 mm land areas

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
ESH2D-E3/52T	0.096	52T	750	7" diameter plastic tape and reel		
ESH2D-E3/5BT	0.096	5BT	3200	13" diameter plastic tape and reel		
ESH2DHE3/52T (1)	0.096	52T	750	7" diameter plastic tape and reel		
ESH2DHE3/5BT (1)	0.096	5BT	3200	13" diameter plastic tape and reel		

Note

RATINGS AND CHARACTERISTICS CURVES

(T_A = 25 °C unless otherwise noted)





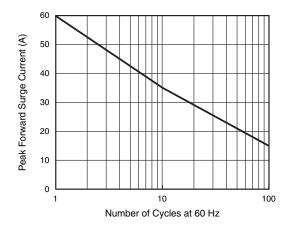


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

⁽¹⁾ AEC-Q101 qualified

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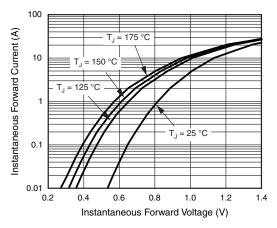


Fig. 3 - Typical Instantaneous Forward Characteristics

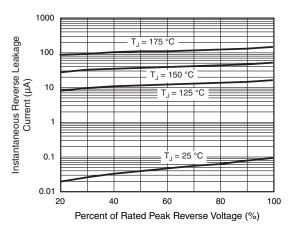


Fig. 4 - Typical Reverse Leakage Characteristics

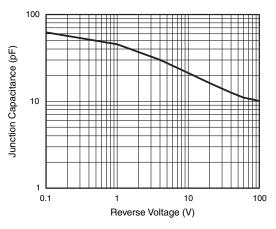


Fig. 5 - Typical Junction Capacitance

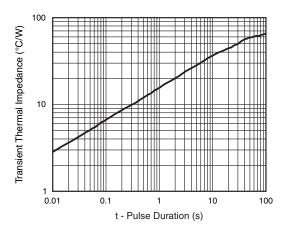
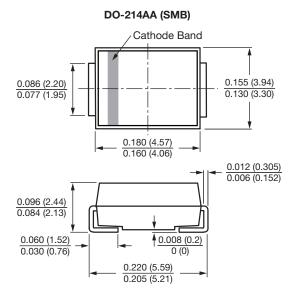
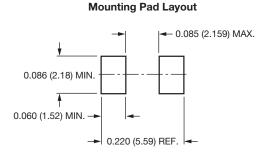


Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)







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